

## Supplementary Materials

### A Study on Thermal Behaviour of Thermal Barrier Coating: Investigation of Particle Size, YSZ/Polysilazane, Time and Temperature Curing Effect

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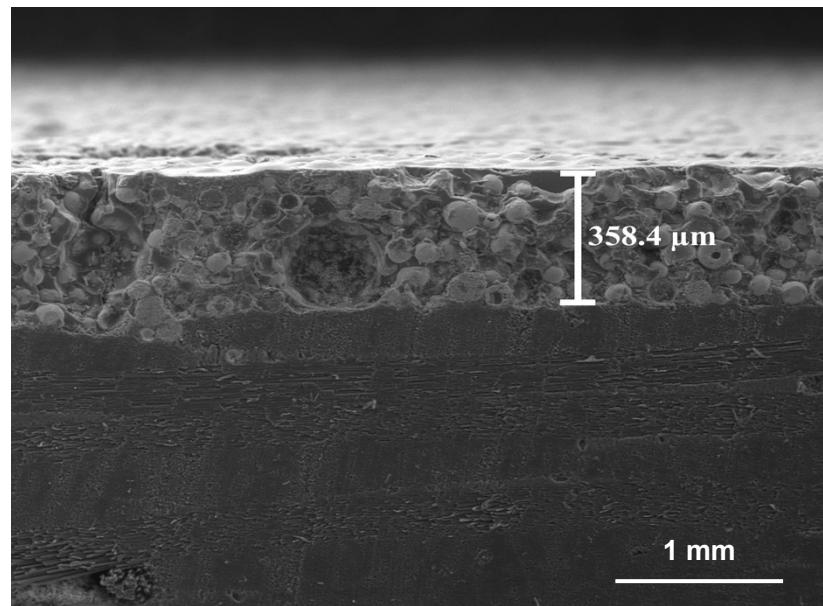
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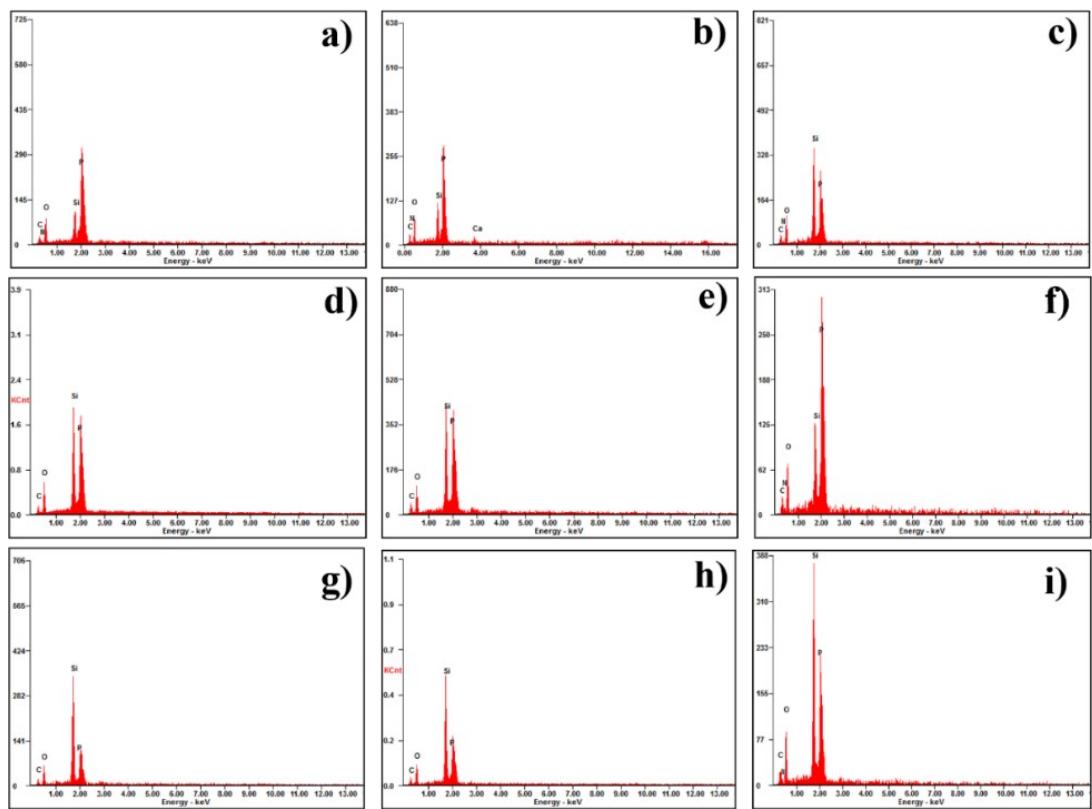
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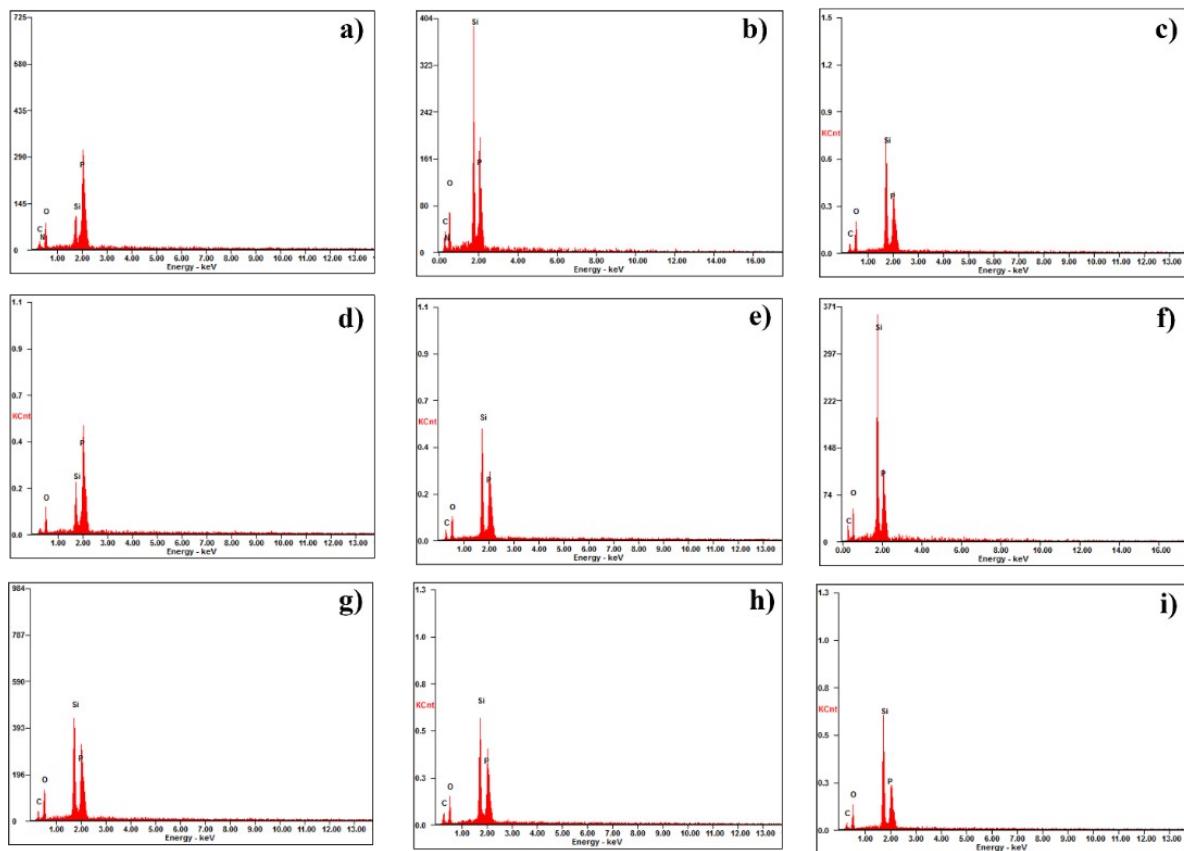
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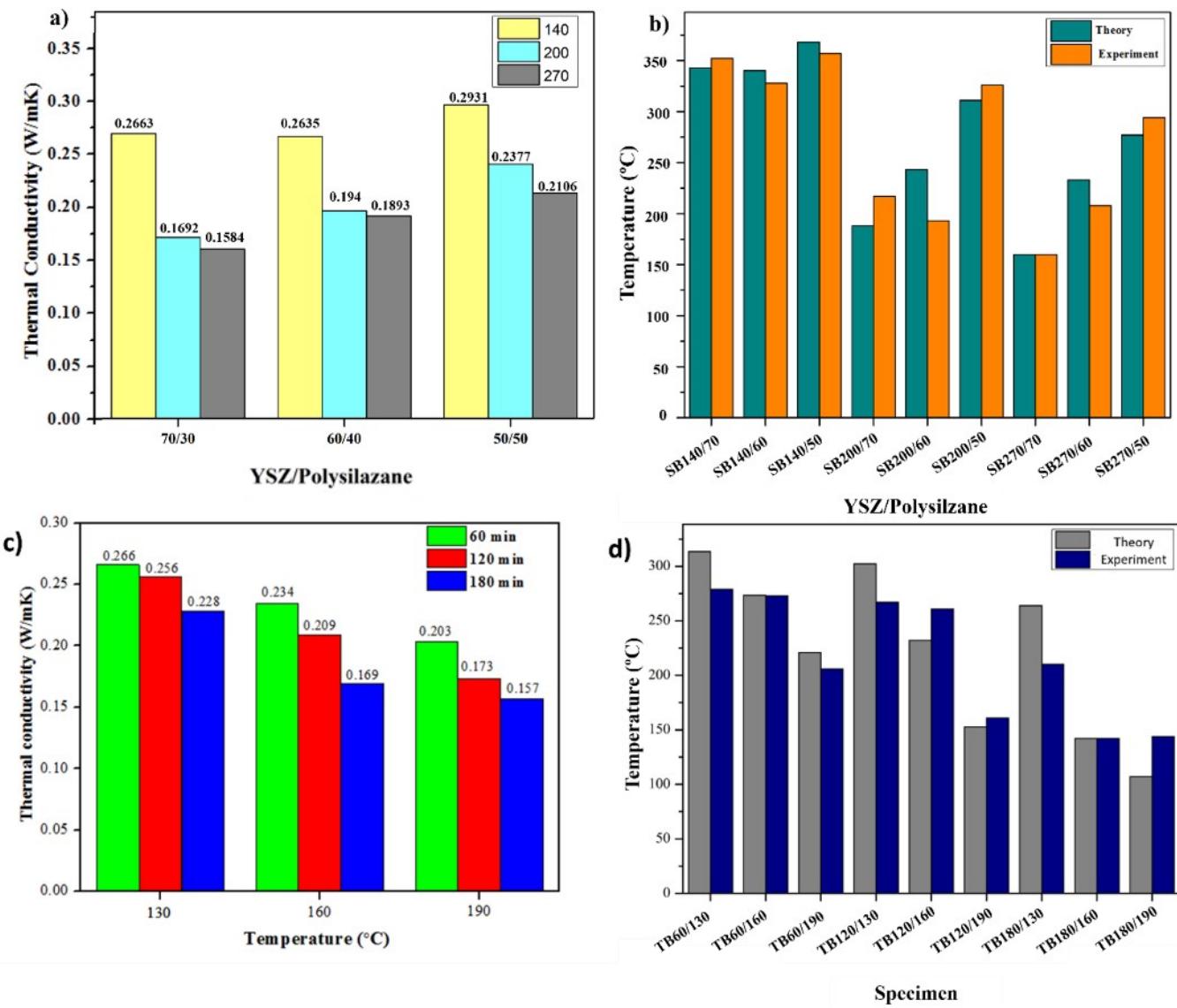
**Figure S1.** Micro cross-section of SB140/70



**Figure S2.** Elemental distribution of specimen (a) SB140/70, (b) SB140/60, (c) SB140/50, (d) SB200/70, (e) SB200/60, (f) SB200/50, (g) SB270/70, (h) SB270/60, and (i) SB270/50



**Figure S3.** Elemental distribution of specimen (a)TB60/130, (b)TB60/160, (c)TB60/190, (d) TB120/130, (e)TB120/160, (f)TB120/190, (g) TB180/130, (h)TB180/160, and (i)TB180/190



**Figure S4.** Thermal conductivity of (a) particle size and YSZ/polysilazane variations (c) time and temperature curing and Comparison of the final temperature based on theoreticals and experiments of (b) particle size and YSZ/polysilazane variations (d) time and temperature curing